



(12) **Patent Application Publication**  
**Chang et al.**

(10) **Pub. No.: US 2015/0060841 A1**  
(43) **Pub. Date: Mar. 5, 2015**

## Publication Classification

(51) **Int. Cl.**  
**H01L 51/52** (2006.01)  
**H01L 27/32** (2006.01)

(52) **U.S. Cl.**  
CPC ..... *H01L 51/5253* (2013.01); *H01L 51/52*  
(2013.01); *H01L 51/5218* (2013.01); *H01L*  
27/32 (2013.01)  
USPC ..... 257/40

(57) **ABSTRACT**

### Related U.S. Application Data

An organic light emitting display apparatus that includes a substrate, an organic light emitting unit formed on the substrate, a reflection member disposed on a non-light emitting region of the organic light emitting unit, and a sealing member that seals the organic light emitting unit. The organic light emitting display apparatus can function as a display apparatus or a mirror.

Mar. 18, 2008 (KR) ..... 2008-24906

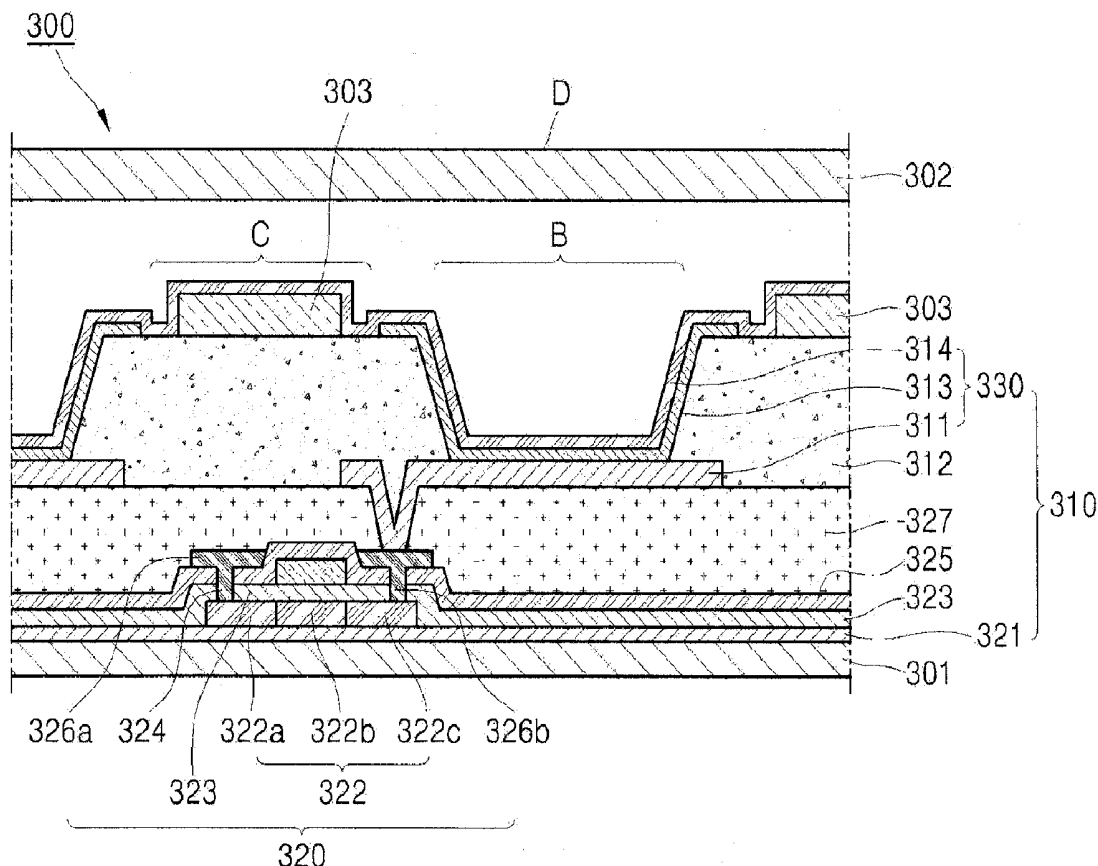


FIG. 1

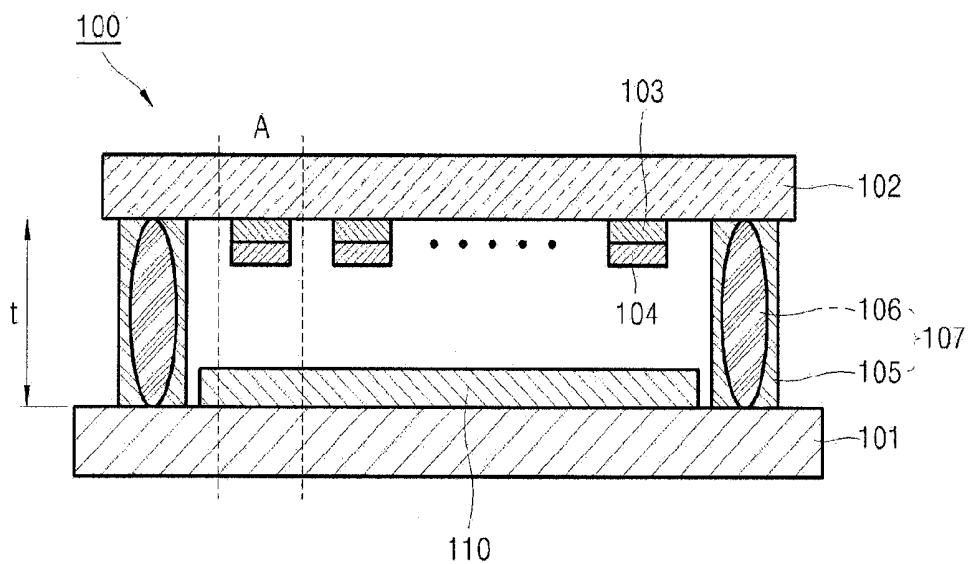


FIG. 2

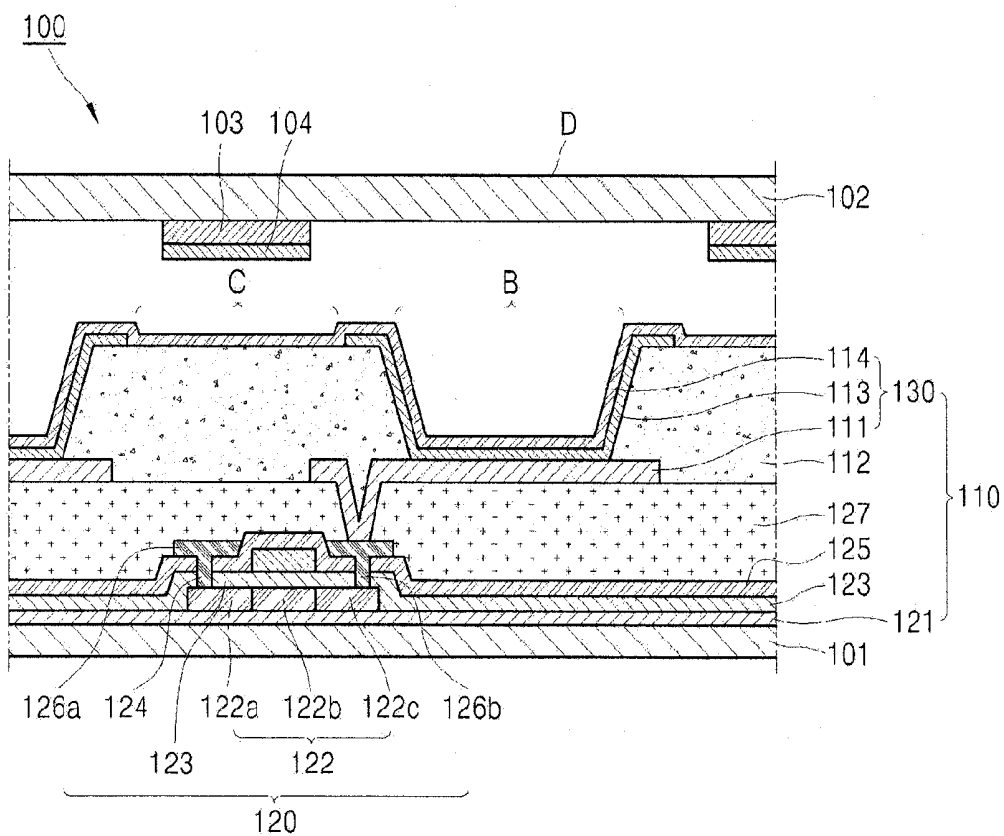


FIG. 3

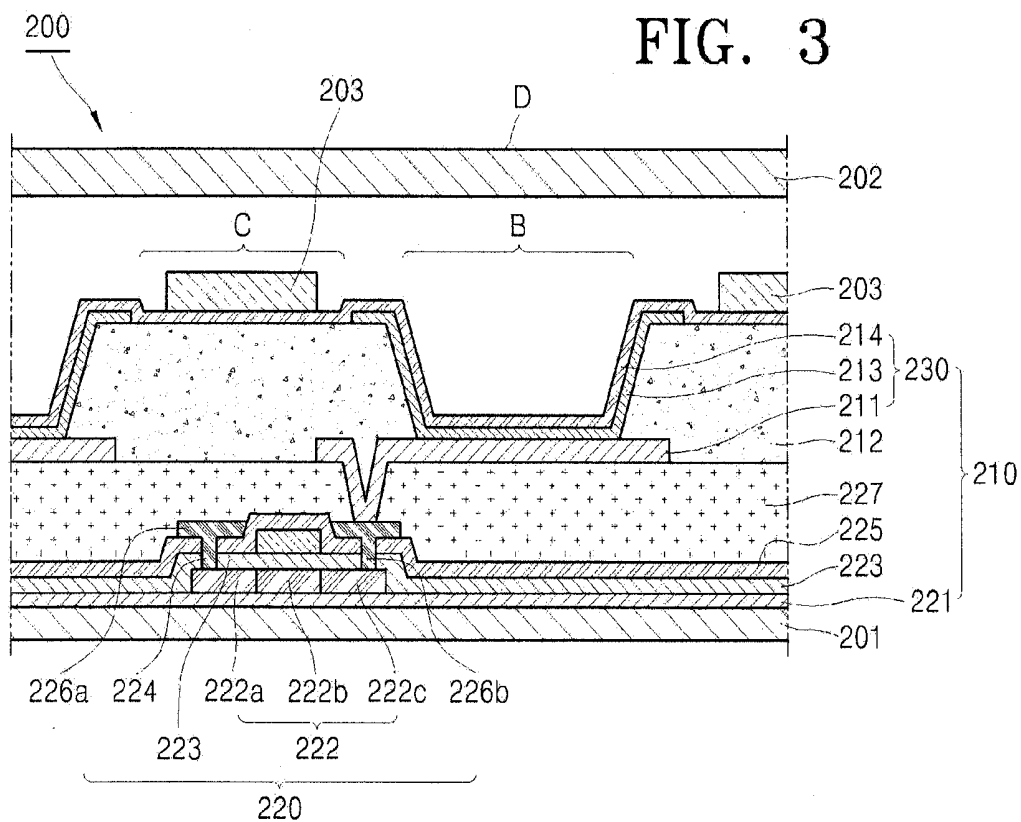
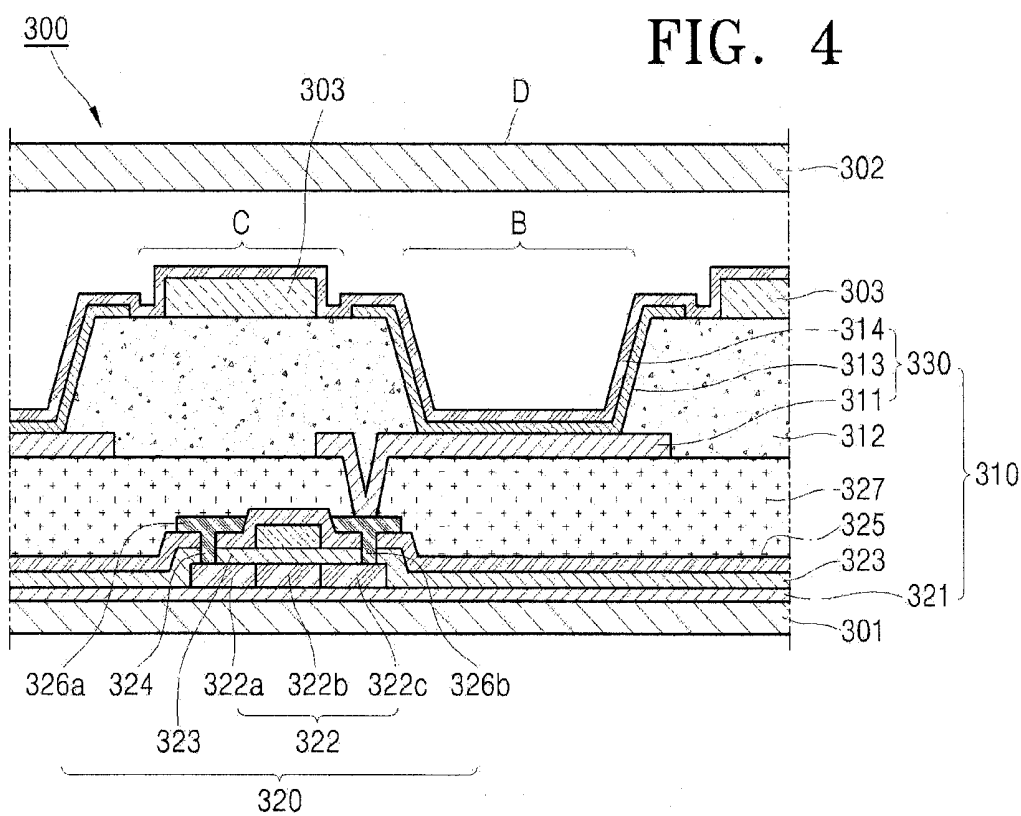


FIG. 4



## ORGANIC LIGHT EMITTING DISPLAY APPARATUS

### CROSS-REFERENCE TO RELATED APPLICATION

[0001] This application claims the benefit of Korean Patent Application No. 2008-24906, filed Mar. 18, 2008 in the Korean Intellectual Property Office, the disclosure of which is incorporated herein by reference.

### BACKGROUND OF THE INVENTION

[0002] 1. Field of the Invention

[0003] Aspects of the present invention relate to an organic light emitting display apparatus, and more particularly, to an organic light emitting display apparatus functioning both as a display apparatus and as a mirror.

[0004] 2. Description of the Related Art

[0005] Organic light emitting display apparatuses are emissive display apparatuses that generate light by re-combination of electrons and holes in a light emitting layer when a voltage is applied to an organic film that includes an anode, a cathode, and an organic light emitting layer interposed between the anode and the cathode. Organic light emitting display apparatuses are expected to be the next generation of display apparatuses because of their advantages such as light weight, low thickness, wide viewing angle, short response time, and low power consumption as compared to cathode ray tubes or liquid crystal displays.

[0006] In an organic light emitting display apparatus, an organic light emitting device is disposed in a display region. The organic light emitting display apparatus includes a pixel electrode and a facing electrode facing each other, and a light emitting layer interposed between the pixel electrode and the facing electrode. Since the organic light emitting display apparatus is easily damaged by foreign materials such as moisture or oxygen penetrating from the outside, the organic light emitting display apparatus is sealed so that penetration of foreign materials from the outside can be prevented.

### SUMMARY OF THE INVENTION

[0007] To address the above and/or other problems, aspects of the present invention provide an organic light emitting display apparatus that can also function as a mirror where an organic light emitting device of the organic light emitting display apparatus does not generate light.

[0008] One aspect of the present invention provides an organic light emitting display apparatus comprising: a substrate; an organic light emitting unit formed on the substrate; a reflection member disposed on a non-light emitting region of the organic light emitting unit; and a sealing member that seals the organic light emitting unit. The sealing member may be separately disposed from the organic light emitting unit.

[0009] The organic light emitting display apparatus may further comprise a combining member that combines the substrate and the sealing member. The combining member may be disposed along edges of the substrate. The combining member may comprise spacers and a sealant.

[0010] The reflection member may be formed on a surface of the sealing member that faces the organic light emitting unit to correspond to the non-light emitting region of the organic light emitting unit. The organic light emitting display apparatus may further comprise an optical absorption layer on a surface of the reflection member facing the organic light

emitting unit. The reflection member may be formed of a material that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus. The reflection member may be formed of a metal that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus. The reflection member may be formed of Al. The reflection member may have a thickness of 250 Å or more.

[0011] Another aspect of the present invention provides an organic light emitting display apparatus comprising: a substrate; a pixel electrode formed on the substrate; a pixel defining layer that is formed on the pixel electrode and exposes a portion of the pixel electrode; an intermediate layer having a light emitting layer formed on the exposed pixel electrode; a facing electrode formed on the pixel defining layer and the intermediate layer; and a reflection member formed on the facing electrode to correspond to the pixel defining layer.

[0012] The reflection member may be formed of a material that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus. The reflection member may be formed of a metal that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus. The reflection member may be formed of Al. The reflection member may have a thickness of 250 Å or more. The pixel electrode may be a reflective electrode and the facing electrode may be a transparent electrode.

[0013] A third aspect of the present invention provides an organic light emitting display apparatus comprising: a substrate; a pixel electrode formed on the substrate; a pixel defining layer that is formed on the pixel electrode and exposes a portion of the pixel electrode; an intermediate layer having a light emitting layer formed on the exposed pixel electrode; a reflection member formed on the facing electrode to correspond to the pixel defining layer; and a facing electrode formed to cover the intermediate layer and the reflection member.

[0014] The reflection member may be formed of a material that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus. The reflection member may be formed of a metal that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus. The reflection member may have a thickness of 250 Å or more. The pixel electrode may be a reflective electrode and the facing electrode may be a transparent electrode. An organic light emitting display apparatus having the above structure can function both as a display apparatus and a mirror.

[0015] Additional aspects and/or advantages of the invention will be set forth in part in the description which follows and, in part, will be obvious from the description, or may be learned by practice of the invention.

### BRIEF DESCRIPTION OF THE DRAWINGS

[0016] These and/or other aspects and advantages of the invention will become apparent and more readily appreciated from the following description of the embodiments, taken in conjunction with the accompanying drawings of which:

[0017] FIG. 1 is a schematic cross-sectional view of an organic light emitting display apparatus according to an embodiment of the present invention;

[0018] FIG. 2 is an enlarged cross-sectional view of portion A of FIG. 1;

[0019] FIG. 3 is a schematic cross-sectional view of an organic light emitting display apparatus according to a second embodiment of the present invention; and

[0020] FIG. 4 is a schematic cross-sectional view of an organic light emitting display apparatus according to a third embodiment of the present invention.

#### DETAILED DESCRIPTION OF THE EMBODIMENTS

[0021] Reference will now be made in detail to the present embodiments of the present invention, examples of which are illustrated in the accompanying drawings, wherein like reference numerals refer to the like elements throughout. The embodiments are described below in order to explain the present invention by referring to the figures. Moreover, it is to be understood that where it is stated herein that one layer is “formed on” or “disposed on” a second layer, or interposed between two layers, the first layer may be formed or disposed directly on the other layers or there may be intervening layers between the first layer and the other layers. Further, as used herein, the term “formed on” is used with the same meaning as “located on” or “disposed on” or “interposed” and is not meant to be limiting regarding any particular fabrication process.

[0022] FIG. 1 is a schematic cross-sectional view of an organic light emitting display apparatus 100 according to an embodiment of the present invention. FIG. 2 is an enlarged cross-sectional view of portion A of FIG. 1. Referring to FIGS. 1 and 2, the organic light emitting display apparatus 100 includes a substrate 101, an organic light emitting unit 110, a reflection member 103, a light absorption layer 104, and a combining member 107.

[0023] The substrate 101 can be formed of a material such as transparent glass, a plastic sheet, or silicon, and may be transparent as well as flexible or rigid. The substrate 101 is not limited to the above materials, and can be also formed of a metal plate.

[0024] The organic light emitting unit 110 is formed on the substrate 101. In the case of an active matrix organic light emitting display apparatus, the organic light emitting unit 110 can include one or more organic light emitting devices 130 and thin film transistors 120. The organic light emitting devices 130 and the thin film transistors 120 will now be described. As depicted in FIG. 2, the organic light emitting unit 110 includes a light emitting region B where the organic light emitting device 130 is formed and a non-light emitting region C where the organic light emitting device 130 is not formed. The reflection member 103 can be disposed in the non-light emitting region C, which will be described later. This embodiment is not limited to an active matrix organic light emitting display apparatus but can also be applied to a passive matrix organic light emitting display apparatus.

[0025] A sealing member 102 is disposed on an upper side of the organic light emitting unit 110 and is joined to the substrate 101. That is, as depicted in FIG. 1, the sealing member 102 can be disposed separately from the organic light emitting unit 110, and can be joined to the substrate 101 via the combining member 107. The sealing member 102 can be glass or a plastic, for example, an acrylic. In the case of a top emission type organic light emitting display apparatus, the sealing member 102 can be formed of an electrical insulating material having high transparency with respect to light generated from the organic light emitting unit 110. The electrical insulating material can be a transparent glass such as alkali

glass or non-alkali glass; a transparent polymer such as polyethylene terephthalate, polycarbonate, polyether sulfone, polyvinyl fluoride (PVF) or an acrylic; a transparent ceramic such as zirconia; or quartz.

[0026] The reflection member 103 can be disposed in the non-light emitting region C of the organic light emitting unit 110. In particular, in the organic light emitting display apparatus 100 depicted in FIG. 1, the reflection member 103 can be formed on a surface of the sealing member 102 facing the organic light emitting unit 110 so that the reflection member 103 can correspond to the non-light emitting region C of the organic light emitting unit 110. More specifically, as depicted in FIG. 2, the reflection member 103 can be formed on the surface of the sealing member 102 that faces the organic light emitting unit 110 so that the reflection member 103 can correspond to a pixel defining layer 112, both of which are positioned in the non-light emitting region C. The reflection member 103 can reflect light proceeding towards the organic light emitting unit 110 from outside of the organic light emitting display apparatus 100. Thus, when the organic light emitting unit 110 does not emit light, the reflection member 103 can function as a mirror by reflecting light proceeding towards the organic light emitting unit 110 from outside of the organic light emitting display apparatus 100.

[0027] Also, since the reflection member 103 is disposed in the non-light emitting region C of the organic light emitting unit 110, and not in the light emitting region B, an optical path through which light emitted from the light emitting region B can be emitted to the outside of the organic light emitting display apparatus 100 can be ensured. In the case of a top emission type organic light emitting display apparatus 100, since the reflection member 103 is disposed in the non-light emitting region C, the light emission surface can function not only as a display unit but also as a mirror. In the case of a bottom emission type organic light emitting display apparatus, the light emission area D can function as a display unit and the non-emission surface can function as a mirror.

[0028] The reflection member 103 is formed of a material that can reflect light proceeding towards the reflection member 103 from outside of the organic light emitting display apparatus 100. For example, the reflection member 103 can be formed of a metal selected from the group consisting of Al, Cr, Ag, Fe, Pt and Hg. Preferably, Al may be used to form the reflection member 103. When Al is used, and the reflection member 103 has a thickness greater than 250 Å, the reflectivity of visible light is 75 to 90%. The light absorption layer 104 can be formed on a surface of the reflection member 103 that faces the organic light emitting unit 110. The light absorption layer 104 absorbs light emitted from the organic light emitting unit 110 and passing through the reflection member 103. The light absorption layer 104 can be a black matrix. The light absorption layer 104 can be formed of a metal such as Cr or Mo having relatively low reflectivity, or can be formed of an opaque insulating material such as CrOx or MoOx.

[0029] The combining member 107 joins the substrate 101 with the sealing member 102. The combining member 107 can be disposed on edges of the substrate 101, and the organic light emitting unit 110 is therefore surrounded by the combining member 107. The combining member 107 can include a sealant 105 and spacers 106. The spacers 106 are fully enclosed in the sealant 105, and the spacers 106 can maintain a gap t between the substrate 101 and the sealing member 102. The gap t between the substrate 101 and the sealing member

**102** can be controlled by controlling the length of the spacers **106**. Also, a mura effect such as a Newton ring phenomenon that can occur between the substrate **101** and the sealing member **102** can be prevented by controlling the length of the gap **t** of the spacers **106**.

**[0030]** As cited above, FIG. 2 is an enlarged cross-sectional view of portion A of FIG. 1, that is, the specific configuration of the organic light emitting unit **110**. Referring to FIG. 2, at least one thin film transistor **120** is formed on the substrate **101** and at least one organic light emitting device **130** is formed on a corresponding thin film transistor **120**. The organic light emitting device **130** can include a pixel electrode **111** electrically connected to the thin film transistor **120**, a facing electrode **114** disposed on the entire surface of the substrate **101**, and an intermediate layer **113** that includes at least one light emitting layer and is disposed between the pixel electrode **111** and the facing electrode **114**.

**[0031]** The thin film transistor **120** having a gate electrode **124**, a source electrode **126a** and a drain electrode **126b**, a semiconductor layer **122**, a gate insulating film **123**, and an interlayer insulating layer **125** is formed on the substrate **101**. Also, the shape of the thin film transistor **120** is not limited to the shape depicted in FIG. 2, and various thin film transistors such as an organic thin film transistor in which the semiconductor layer **122** is formed of an organic material or a silicon thin film transistor in which the semiconductor layer **122** is formed of silicon can be used. If necessary, a buffer layer **121** formed of silicon oxide  $\text{SiO}_2$ , silicon nitride  $\text{Si}_3\text{N}_4$ , or silicon oxynitride  $\text{SiO}_x\text{N}_y$ , can further be included between the thin film transistor **120** and the substrate **101**. The buffer layer **121** improves the device characteristics by preventing penetration of impurities generated from the substrate **101** into the semiconductor layer **122**.

**[0032]** The semiconductor layer **122** is formed on the buffer layer **121**, and can be an amorphous silicon film or a crystalline silicon film. The semiconductor layer **122** can include a source region **122a**, a drain region **122c**, and a channel region **122b**.

**[0033]** The semiconductor layer **122** is enclosed by the gate insulating film **123**. The gate electrode **124** that corresponds to the semiconductor layer **122** and the interlayer insulating layer **125** that encloses the gate electrode **124** are formed on an upper surface of the gate insulating film **123**.

**[0034]** The source electrode **126a** and the drain electrode **126b** respectively contact the source region **122a** and the drain region **122c** through contact holes (not shown in the Figures) that are formed in the gate insulating film **123** and the interlayer insulating layer **125**.

**[0035]** The organic light emitting device **130** includes the pixel electrode **111** and the facing electrode **114**, that face each other, and the intermediate layer **113** that is interposed between the pixel electrode **111** and the facing electrode **114** and is formed of an organic material. The intermediate layer **113** includes at least one light emitting layer, and can include a plurality of layers, which will be described later.

**[0036]** The pixel electrode **111** functions as an anode electrode, and the facing electrode **114** functions as a cathode electrode. Of course, the polarity of the pixel electrode **111** and the facing electrode **114** can be designed with opposite polarity.

**[0037]** The pixel electrode **111** can be a transparent electrode or a reflective electrode. If the pixel electrode **111** is a transparent electrode, the pixel electrode **111** can be formed of ITO, IZO, ZnO, or  $\text{In}_2\text{O}_3$ . If the pixel electrode **111** is a

reflective electrode, the pixel electrode **111** can include a reflective film formed of Ag, Mg, Al, Pt, Pd, Au, Ni, Nd, Ir, Cr, or a combination or alloy of these metals and a film formed of ITO, IZO, ZnO, or  $\text{In}_2\text{O}_3$  formed on the reflective film.

**[0038]** The facing electrode **114** can also be a transparent electrode or a reflective electrode. If the facing electrode **114** is a transparent electrode, the facing electrode **114** can include a film deposited to face the intermediate layer **113** interposed between the pixel electrode **111** and the facing electrode **114** using Li, Ca, LiF/Ca, LiF/Al, Al, Mg, or a combination of these materials and an auxiliary electrode or a bus electrode layer (not shown in the Figures) that is formed of a material used to form the transparent electrode, such as ITO, IZO, ZnO, or  $\text{In}_2\text{O}_3$ , on the film. If the facing electrode **114** is a reflective electrode, the facing electrode **114** can be formed by depositing Li, Ca, LiF/Ca, Al, Mg, or a combination of these materials.

**[0039]** Meanwhile, the pixel defining layer **112** is formed on an outer side of the pixel electrode **111** in order to cover the edges of the pixel electrode **111**. Beside the function of defining a light emission region, the pixel defining layer **112**, prevents the pixel electrode **111** and the facing electrode **114** from electrically disconnecting from each other by preventing the occurrence of an electric field concentration phenomenon at an edge portion of the pixel electrode **111** through widening the gap between the edge of the pixel electrode **111** and the facing electrode **114**.

**[0040]** Various intermediate layers **113** that include at least a light emitting layer can be included between the pixel electrode **111** and the facing electrode **114**. The intermediate layer **113** can be formed of a small molecule organic material or a polymer organic material.

**[0041]** If the intermediate layer **113** is formed of a small molecule organic material, the intermediate layer can be formed in a single or a composite structure by stacking a hole injection layer (HIL), a hole transport layer (HTL), an emission layer (EML), an electron transport layer (ETL), and an electron injection layer (EIL) (the individual layers are not separately shown in the Figures). An organic material that can be used to form the intermediate layer **113** includes copper phthalocyanine (CuPc), N,N'-Di(naphthalene-1-yl)-N,N'-diphenyl-benzidine ( $\alpha$ -NPB), and tris-8-hydroxyquinoline aluminum (Alq3). The small molecule organic material layers can be formed by a vacuum evaporation method using masks.

**[0042]** If the intermediate layer **113** is formed of a polymer organic material, the intermediate layer **113** can have a structure in which an HTL and an EML are included. The polymer HTL can be formed of poly-(2,4)-ethylene-dihydroxy thiophene (PEDOT) and the light emitting layer can be formed of poly-phenylenevinylene (PPV) or polyfluorene.

**[0043]** The organic light emitting device **130** is electrically connected to the thin film transistor **120** formed thereunder. In this case, if a planarizing film **127** covering the thin film transistor **120** is formed, the organic light emitting device **130** is disposed on the planarizing film **127**, and the pixel electrode **111** of the organic light emitting device **130** is electrically connected to the thin film transistor **120** through a contact hole (not shown in the Figures) that is formed in the planarizing film **127**.

**[0044]** FIG. 3 is a schematic cross-sectional view of an organic light emitting display apparatus **200** according to a second embodiment of the present invention. The organic light emitting display apparatus **200** of FIG. 3 is different

from the organic light emitting display apparatus 100 of FIGS. 1 and 2 in that a reflection member 203 is positioned at a different location from the reflection member 103. That is, a substrate 201, an organic light emitting unit 210, a thin film transistor 220, a buffer layer 221, a semiconductor layer 222, a source region 222a, a drain region 222c, a channel region 222b, a gate electrode 224, a source electrode 226a, a drain electrode 226b, a gate insulating film 223, an interlayer insulating layer 225, a planarizing film 227, a pixel defining layer 212, an organic light emitting device 230, a pixel electrode 211, an intermediate layer 213, a facing electrode 214, and a sealing member 202 in the organic light emitting display apparatus 200 of FIG. 3 all are respectively identical to the substrate 101, the thin film transistor 120, the buffer layer 121, the semiconductor layer 122, the source region 122a, the drain region 122c, the channel region 122b, the gate electrode 124, the source electrode 126a, the drain electrode 126b, the gate insulating film 123, the interlayer insulating layer 125, the planarizing film 127, the pixel defining layer 112, the organic light emitting device 130, the pixel electrode 111, the intermediate layer 113, the facing electrode 114, and the sealing member 102 in the organic light emitting display apparatus 100 of FIG. 2, and thus, the descriptions thereof will not be repeated.

[0045] Referring to FIG. 3, the reflection member 203 is disposed in a non-light emitting region C of the organic light emitting unit 210. More specifically, the reflection member 203 can be formed on the facing electrode 214 to correspond to the pixel defining layer 212. The reflection member 203 of the organic light emitting display apparatus 200 and the reflection member 103 of the organic light emitting display apparatus 100 are both positioned in the non-light emitting region C. However, the reflection member 203 of the organic light emitting display apparatus 200 is not disposed on the sealing member 202 but on the facing electrode 214 formed on the pixel defining layer 212. In the case of the top emission type organic light emitting display apparatus 200, light generated from the organic light emitting device 230 is emitted to the outside through the sealing member 202. However, since the reflection member 203 is disposed on the facing electrode 214 formed on the pixel defining layer 212 which is not formed in a light emitting path, the optical extraction rate can be increased.

[0046] The reflection member 203 can be formed of a material that can reflect light proceeding towards the reflection member 203 from outside of the organic light emitting display apparatus 200, and in particular, can be formed of a metal that can reflect light. For example, the reflection member 203 can be formed of Al, Cr, Ag, Fe, Pt or Hg. Preferably, the metal can be Al. If Al is used, the reflection member 203 has a thickness of 250 Å or greater, and the reflected percentage of visible light is 75 to 90%.

[0047] Since the reflection member 203 is formed of a material that can reflect light proceeding towards the reflection member 203 from outside of the organic light emitting display apparatus 200, when the organic light emitting device 230 does not emit light, the reflection member 203 can perform as a mirror by reflecting light entering from the outside. In the organic light emitting display apparatus 200 having the above configuration, a single light emission face can simultaneously perform as a display and as a mirror.

[0048] FIG. 4 is a schematic cross-sectional view of an organic light emitting display apparatus 300 according to another embodiment of the present invention. The organic

light emitting display apparatus 300 of FIG. 4 is different from the organic light emitting display apparatus 100 of FIGS. 1 and 2 in that a reflection member 303 is positioned at a different location from the reflection member 103. That is, a substrate 301, an organic light emitting unit 310, a thin film transistor 320, a buffer layer 321, a semiconductor layer 322, a source region 322a, a drain region 322c, a channel region 322b, a gate electrode 324, a source electrode 326a, a drain electrode 326b, a gate insulating film 323, an interlayer insulating layer 325, a planarizing film 327, a pixel defining layer 312, an organic light emitting device 330, a pixel electrode 311, an intermediate layer 313, a facing electrode 314, and a sealing member 302 in the organic light emitting display apparatus 300 of FIG. 4 all are respectively identical to the substrate 101, the thin film transistor 120, the buffer layer 121, the semiconductor layer 122, the source region 122a, the drain region 122c, the channel region 122b, the gate electrode 124, the source electrode 126a, the drain electrode 126b, the gate insulating film 123, the interlayer insulating layer 125, the planarizing film 127, the pixel defining layer 112, the organic light emitting device 130, the pixel electrode 111, the intermediate layer 113, the facing electrode 114, and the sealing member 102 in the organic light emitting display apparatus 100 of FIG. 2, and thus, the descriptions thereof will not be repeated.

[0049] Referring to FIG. 4, the reflection member 303 is disposed on a non-light emitting region C. More specifically, the reflection member 303 is disposed on the pixel defining layer 312, and the facing electrode 314 can be formed to cover the intermediate layer 313 and the reflection member 303. In the case of the top emission type organic light emitting display apparatus 300, since the facing electrode 314 is a transparent electrode, although the reflection member 303 is covered by the facing electrode 314, light proceeding towards the reflection member 303 from the outside can be reflected. Thus, the organic light emitting display apparatus 300 can function as a mirror where the organic light emitting device 330 does not emit light. Since the reflection member 303 is not disposed on a light emitting path in the organic light emitting device 330, the optical extraction rate of the organic light emitting display apparatus 300 can be increased.

[0050] The reflection member 303 is formed of a material that can reflect light proceeding towards the reflection member 303 from the outside of the organic light emitting display apparatus 300, and in particular, can be formed of a metal that can reflect light. For example, the reflection member 303 can be formed of Al, Cr, Ag, Fe, Pt or Hg. Preferably the reflection member 303 can be formed of Al. As described above, if Al is used, the reflection member 303 has a thickness of 250 Å or greater, and the reflected percentage of visible light is 75 to 90%.

[0051] Although a few embodiments of the present invention have been shown and described, it would be appreciated by those skilled in the art that changes may be made in this embodiment without departing from the principles and spirit of the invention, the scope of which is defined in the claims and their equivalents.

1. An organic light emitting display apparatus comprising:
  - a substrate;
  - an organic light emitting unit on the substrate;
  - a reflection member on a non-light emitting region of the organic light emitting unit; and
  - a sealing member that seals the organic light emitting unit.

2. The organic light emitting display apparatus of claim 1, wherein the sealing member is separately disposed from the organic light emitting unit.

3. The organic light emitting display apparatus of claim 2, further comprising a combining member that joins the substrate and the sealing member.

4. The organic light emitting display apparatus of claim 3, wherein the combining member is disposed along edges of the substrate.

5. The organic light emitting display apparatus of claim 3, wherein the combining member further comprises spacers and a sealant.

6. The organic light emitting display apparatus of claim 1, wherein the reflection member is on a surface of the sealing member that faces the organic light emitting unit to correspond to the non-light emitting region of the organic light emitting unit.

7. The organic light emitting display apparatus of claim 6, further comprising a light absorption layer on a surface of the reflection member facing the organic light emitting unit.

8. The organic light emitting display apparatus of claim 1, wherein the reflection member comprises a material that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus.

9. The organic light emitting display apparatus of claim 8, wherein the reflection member comprises a metal that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus.

10. The organic light emitting display apparatus of claim 1, wherein the reflection member comprises Al.

11. The organic light emitting display apparatus of claim 10, wherein the reflection member has a thickness of 250 Å or more.

12-17. (canceled)

18. An organic light emitting display apparatus comprising:

- a substrate;
- a pixel electrode on the substrate;
- a pixel defining layer on the pixel electrode and exposing a portion of the pixel electrode;

an intermediate layer having a light emitting layer on the exposed pixel electrode;

a reflection member on the facing electrode to correspond to the pixel defining layer; and

a facing electrode covering the intermediate layer and the reflection member.

19. The organic light emitting display apparatus of claim 18, wherein the reflection member comprises a material that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus.

20. The organic light emitting display apparatus of claim 19, wherein the reflection member comprises a metal that reflects light proceeding towards the reflection member from outside of the organic light emitting display apparatus.

21. The organic light emitting display apparatus of claim 20, wherein the reflection member comprises Al.

22. The organic light emitting display apparatus of claim 21, wherein the reflection member has a thickness of 250 Å or more.

23. The organic light emitting display apparatus of claim 18, wherein the pixel electrode is a reflective electrode and the facing electrode is a transparent electrode.

24. The organic light emitting display apparatus of claim 12, further comprising:

- an absorption layer on each reflection member;
- an organic light emitting unit on the substrate; and
- a sealing member that seals the organic light emitting unit, wherein:
  - each reflection member is on the surface of the sealing member facing the substrate, and
  - each absorption layer is between the reflection member and the substrate.

25. (canceled)

26. The organic light emitting display apparatus of claim 12, wherein the reflection member is between the facing electrode and the pixel defining layer.

27-35. (canceled)

\* \* \* \* \*



专利名称(译)	有机发光显示装置		
公开(公告)号	<a href="#">US20150060841A1</a>	公开(公告)日	2015-03-05
申请号	US14/537811	申请日	2014-11-10
[标]申请(专利权)人(译)	三星显示有限公司		
申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
当前申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
[标]发明人	CHANG SEUNG WOOK KIM HYE DONG KIM MU HYUN		
发明人	CHANG, SEUNG-WOOK KIM, HYE-DONG KIM, MU-HYUN		
IPC分类号	H01L51/52 H01L27/32		
CPC分类号	H01L51/5253 H01L27/32 H01L51/5218 H01L51/52 H01L27/3246 H01L51/5246 H01L51/525 H01L51/5271		
优先权	1020080024906 2008-03-18 KR		
其他公开文献	US9882166		
外部链接	<a href="#">Espacenet</a> <a href="#">USPTO</a>		

## 摘要(译)

一种有机发光显示装置，包括基板，形成在基板上的有机发光单元，设置在有机发光单元的非发光区域上的反射构件，以及密封有机发光单元的密封构件。有机发光显示设备可以用作显示设备或镜子。

